

## 1 Hz Interrupt Generator

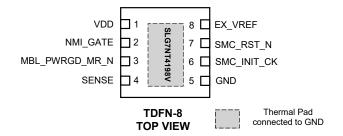
#### **General Description**

Renesas SLG7NT4198V is a low power and small form device. The SoC is housed in a 2mm x 2mm TDFN package which is optimal for using with small devices.

#### **Features**

- Low Power Consumption
- 3.3V Supply
- Pb-Free / RoHS Compliant
- Halogen-Free
- TDFN-8 Package

### **Pin Configuration**



### **Output Summary**

- 1 Output Push Pull
- 1 Output Open Drain



# 1 Hz Interrupt Generator

Pin Configuration

Pin#	Pin Name	Type	Pin Description
1	VDD	Power	3.3V Supply Voltage
2	NMI_GATE	Input	Digital Input
3	MBL_PWRGD_MR_N	Input	Digital Input
4	SENSE	Input	Analog input
5	GND	GND	Ground
6	SMC_INIT_CK	Output	Push Pull
7	SMC_RST_N	Output	Open Drain
8	EX_VREF	Input	Analog input
Exposed Bottom Pad	GND	GND	Ground

**Ordering Options & Configuration** 

Part Number	Package Type
SLG7NT4198V	V = TDFN-8
SLG7NT4198VTR	VTR = TDFN-8 – Tape and Reel (3k units)



# 1 Hz Interrupt Generator

**Absolute Maximum Ratings** 

Parameter	Min.	Max.	Unit
V <sub>DD</sub> to GND	-0.3	4.6	V
Voltage at input pins	-0.3	4.6	V
Current at input pin	-1.0	1.0	mA
Storage temperature range	-65	150	°C
Junction temperature		150	°C

## **Electrical Characteristics**

Symbol	Parameter	Condition / Note	Min	Тур	Max	Unit
$V_{DD}$	Supply Voltage		3.0	3.3	3.6	V
ΙQ	Quiescent Current	Static Inputs and Outputs		30		μΑ
TA	Operating temperature		-40	25	85	°C
Vair	Analog Input Voltage Range	for PIN8	0		1.5	V
ViH	HIGH-Level Input Voltage	Logic Input	1.8			V
$V_{IL}$	LOW-Level Input Voltage	Logic Input			0.8	V
I <sub>IH</sub>	HIGH-Level Input Leakage Current	Logic Input Pins; VIN=3.3V	-1.0		1.0	μА
I <sub>IL</sub>	LOW-Level Input Leakage Current	Logic Input Pins; VIN=0V	-1.0		1.0	μА
Vон	HIGH-Level Output Voltage	Push Pull Logic Level Outputs	2.4			V
$V_{OL}$	LOW-Level Output Voltage	Push Pull Logic Level Outputs			0.4	V
$V_{OL}$	LOW-Level Output Voltage	Open Drain Logic Level Outputs			0.4	V
Іон	HIGH-Level Output Current	Push Pull		8		mΑ
loL	LOW-Level Output Current	Push Pull		-8		mΑ
loL	LOW-Level Output Current	Open Drain		20		mΑ
Voffset	Analog Comparator Offset Voltage	Analog Comparator 0		±20		mV
V <sub>HYST</sub>	Analog Comparator hysteresis	Analog Comparator 0		50		mV
R <sub>PULL_UP</sub>	Internal Pull Up Resistance	Pull up on PIN3	80	100	120	kΩ
T <sub>DLY0</sub>	Delay0 Time		16	20	24	ms
T <sub>DLY2</sub>	Delay2 Time		1.6	2	2.4	ms
T <sub>StUp</sub>	Start Up Time	After VDD > 2.4V		7		ms

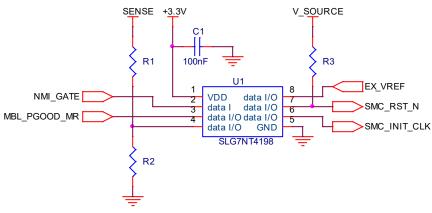


## 1 Hz Interrupt Generator

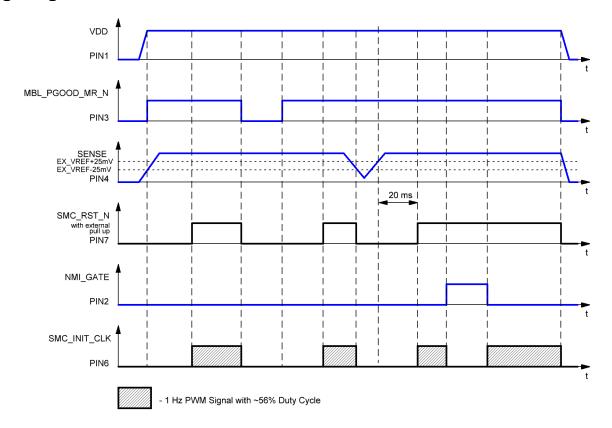
#### **Description**

This is a special oscillator with supervisor system. Three inputs are used to control the oscillator. SENSE (PIN4) controls the voltage supply of the chip. If supply voltage decreases down to the threshold set by EX\_VREF (PIN8), the chip disables the oscillator and sets SMC\_INICK to LOW. When the voltage is bigger than threshold set by EX\_VREF is detected on the SENSE pin, SMC\_RST\_N (PIN7) is set to HIGH with 20 ms delay and enables the oscillator. MBL\_PWRGD\_MR\_N (PIN3) is used for manual reset of SMC\_RST\_N. Use NMI\_GATE (NMI\_GATE) to disable the oscillator.

### **Typical Application Circuit**



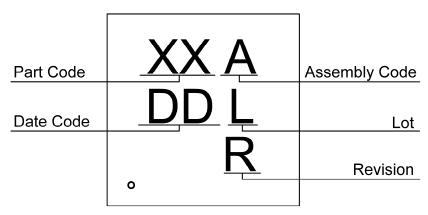
## **Timing Diagrams**





# 1 Hz Interrupt Generator

## **Package Top Marking**



XX - Part Code Field: identifies the specific device configuration

A – Assembly Code Field: Assembly Location of the device.
DD – Date Code Field: Coded date of manufacture

L – Lot Code: Designates Lot #

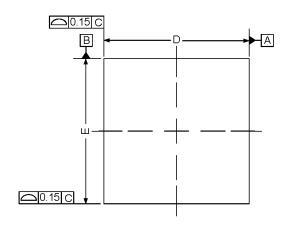
R – Revision Code: Device Revision

Datasheet Revision	Programming Code Number			Date	
1.01	03	ZR	В	02/25/2022	

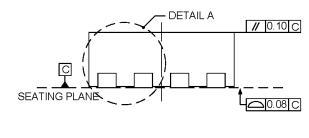


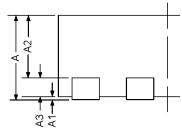
## **Package Drawing and Dimensions**

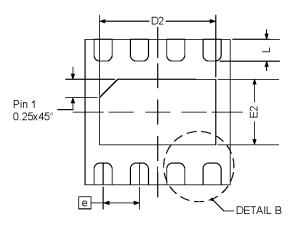
### **TDFN-8 Package**

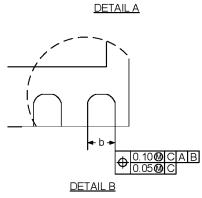


Symbol	Min (mm)	NOM (mm)	Max (mm)
Α	0.70	0.75	0.80
A1	0.00		0.05
A2		0.55	
А3		0.20	
b	0.20	0.25	0.30
D	1.90	2.00	2.10
D2	1.50	1.60	1.70
Е	1.90	2.00	2.10
E2	0.80	0.90	1.00
е		0.50 BSC	
Ĺ	0.20	0.30	0.40











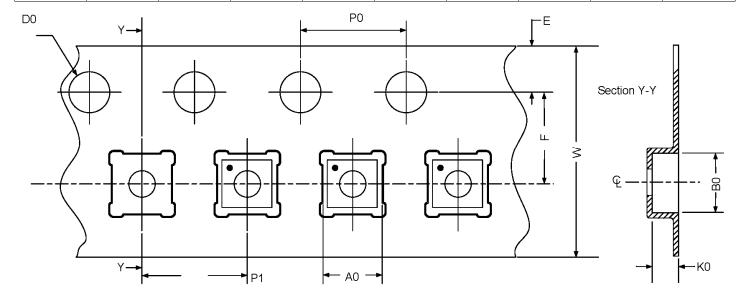
# 1 Hz Interrupt Generator

### **Tape and Reel Specification**

# of	Nominal	Max Units		Reel &	Trailer A		Leader B		Pocket (mm)		
Package Type	Pins	ns Package Hub	Hub Size (mm)	Pockets	Length (mm)	Pockets	Length (mm)	Width	Pitch		
TDFN 8L 2x2mm Green	8	2x2x0.75	3000	3000	178/60	42	168	42	168	8	4

## **Carrier Tape Drawing and Dimensions**

Package Type	Pocket BTM Length (mm)	Pocket BTM Width (mm)	Pocket Depth (mm)	Index Hole Pitch (mm)	Pocket Pitch (mm)	Index Hole Diameter (mm)	Index Hole to Tape Edge (mm)	Index Hole to Pocket Center (mm)	Tape Width (mm)
	A0	В0	K0	P0	P1	D0	E	F	w
TDFN 8L 2x2mm Green	2.3	2.3	1.05	4	4	1.55	1.75	3.5	8



## **Recommended Reflow Soldering Profile**

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 4.6875 mm³ (nominal). More information can be found at <a href="https://www.jedec.org">www.jedec.org</a>.



# 1 Hz Interrupt Generator

# **Datasheet Revision History**

Date	Version	Change
05/29/2013	0.1	New Design
07/09/2013	0.12	Jump to 0.12 version. Changed PWM frequency to 1Hz
07/09/2013	0.13	Updated Device Revision Table
07/11/2013	0.14	Changed PIN7 configuration to Open Drain
08/07/2013	0.15	Updated Device Revision Table
03/04/2014	1.0	Production Release
02/25/2022	1.01	Updated Company name and logo

#### IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use o any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Disclaimer Rev.1.0 Mar 2020)

#### **Corporate Headquarters**

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

#### **Trademarks**

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

#### **Contact Information**

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:

www.renesas.com/contact/